

FGA15N120ANTDTU 1200 V, 15 A NPT Trench IGBT

Features

- NPT Trench Technology, Positive temperature coefficient
- Low Saturation Voltage: $V_{CE(sat), typ}$ = 1.9 V @ I_C = 15 A and T_C = 25°C
- + Low Switching Loss: E_{off, typ} = 0.6 mJ @ I_C = 15 A and T_C = 25 $^\circ\text{C}$
- Extremely Enhanced Avalanche Capability





Using ON Semiconductor's proprietary trench design and

advanced NPT technology, the 1200V NPT IGBT offers

superior conduction and switching performances, high

This device is well suited for the resonant or soft switching appli-

avalanche ruggedness and easy parallel operation.

cation such as induction heating, microwave oven.

Description

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Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector-Emitter Voltage		1200	V	
V _{GES}	Gate-Emitter Voltage		± 20	V	
I _C	Collector Current	@ T _C = 25°C	30	A	
	Collector Current	@ T _C = 100°C	15	A	
I _{CM}	Pulsed Collector Current (Note 1)		45	A	
I _F	Diode Continuous Forward Current	@ T _C = 25°C	30	A	
	Diode Continuous Forward Current	@ T _C = 100°C	15	A	
I _{FM}	Diode Maximum Forward Current		45	A	
P _D	Maximum Power Dissipation	@ T _C = 25°C	186	W	
	Maximum Power Dissipation	@ T _C = 100°C	74	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case for IGBT		0.67	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case for Diode		2.88	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Notes:

(1) Repetitive rating: Pulse width limited by max. junction temperature

Part Number FGA15N120ANTDTU-F109		Top Mark	Package	Packing Method	Reel Size	Tape Width		Quantity 30
			TO-3P	Tube				
Electric	al Characte	pristics of the l		°C unless otherwise poter	4			
Symbol	P	rameter Test Conditions		t Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics						<u> </u>	
	Collector Cut-Of	f Current	$V_{CE} = V_{CE}$	$V_{CE} = V_{CES}$, $V_{CE} = 0$ V			3	mA
	G-E Leakage C	urrent	$V_{CE} = V_{CES}, V_{CE} = 0 V$				± 250	nA
·GE3			- GE - GE	3, CE				
On Charac	teristics							
V _{GE(th)}	G-E Threshold	/oltage	$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = $V_{\rm GE}$		4.5	6.5	8.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage		I _C = 15 A,	$I_{\rm C} = 15 \text{A}, V_{\rm GE} = 15 \text{V}$		1.9	2.4	V
			I _C = 15 A, V _{GE} = 15 V, T _C = 125°C			2.2		V
			I _C = 30 A,	I _C = 30 A, V _{GE} = 15 V		2.3		V
								•
Dynamic C	Innut Canacitan	20	V 30 V	() (= = 0) (2650		рЕ
			f = 1 MHz	f = 1 MHz		1/2		pi nE
C	Reverse Transfe		_			96		pr pF
Ores		o oppositionee				50		рі
Switching	Characteristics							
t _{d(on)}	Turn-On Delay	lime .	$V_{\rm CC} = 600$	V, I _C = 15 A,		15		ns
t _r	Rise Time		R _G = 10 Ω Inductive I	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$		20		ns
t _{d(off)}	Turn-Off Delay	lime				160		ns
t _f	Fall Time					100	180	ns
Eon	Turn-On Switchi	ng Loss				3	4.5	mJ
E _{off}	Turn-Off Switchi	ng Loss				0.6	0.9	mJ
E _{ts}	Total Switching	LOSS				3.6	5.4	mJ
t _{d(on)}	Turn-On Delay	lime	$V_{CC} = 600$	V, I _C = 15 A,		15		ns
t _r	Rise Time		R _G = 10 Ω Inductive I	, V _{GE} = 15 V, oad. T _C = 125°C		20		ns
t _{d(off)}	Turn-Off Delay	lime				170		ns
t _f	Fall Time		_			150		ns
Eon	Turn-On Switchi	ng Loss				3.2	4.8	mJ
E _{off}	Turn-Off Switchi	ng Loss				0.8	1.2	mJ
E _{ts}	Total Switching	LOSS				4.0	6.0	mJ
Qg	Total Gate Char	ge	V _{CE} = 600	V, I _C = 15 A,		120	180	nC
Q _{ge}	Gate-Emitter Ch	arge	V _{GE} = 15 V			16	22	nC
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Symbol	Parameter Diode Forward Voltage	Test Conditions		Min.	Тур.	Max.	Unit
V _{FM}		I _F = 15 A	$T_{C} = 25^{\circ}C$		1.7	2.7	V
			T _C = 125°C		1.8		
t _{rr}	Diode Reverse Recovery Time	I _F = 15 A	$T_{\rm C} = 25^{\circ}{\rm C}$		210	330	ns
		di _F /dt = 200 A/µs	$T_{\rm C} = 125^{\circ}{\rm C}$		280		
I _{rr}	Diode Peak Reverse Recovery Cur- rent		$T_{C} = 25^{\circ}C$		27	40	А
			$T_{\rm C} = 125^{\circ}{\rm C}$		31		
Q _{rr}	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\circ}{\rm C}$		2835	6600	nC
			T _C = 125°C		4340		

Typical Performance Characteristics

Figure 1. Typical Output Characteristics



Figure 2. Typical Saturation Voltage Characteristics



Figure 3. Saturation Voltage vs. Case Temperature at Variant Current Level



Figure 5. Saturation Voltage vs. V_{GE}



Figure 4. Saturation Voltage vs. V_{GE}



Figure 6. Capacitance Characteristics



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Typical Performance Characteristics (Continued)

Figure 7. Turn-On Characteristics vs. Gate Resistance



Figure 8. Turn-Off Characteristics vs. Gate Resistance



Figure 9. Switching Loss vs. Gate Resistance







Figure 10. Turn-On Characteristics vs. Collector Current



Figure 12. Switching Loss vs. Collector Current



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Figure 15. Turn-Off SOA





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Typical Performance Characteristics (Continued)









Figure 18. Reverse Recovery Current



Figure 20. Reverse Recovery Time





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